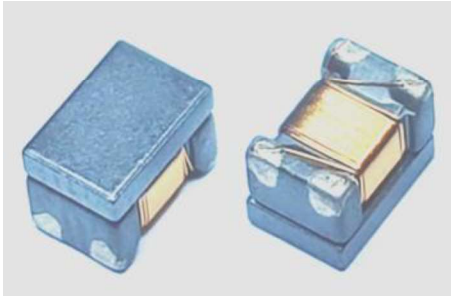




Common Mode Choke ECM322523L-TWA Product Specifications

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Common Mode Choke — ECM322523L-TWA



Application

- Power switch and servers.
- USB communication.
- Telecommunication applications.
- Panel link for LCD panels.
- Common mode noise filtering for automotive CAN-BUS and signal line.

Features

- 100% Lead (Pb)-Free and RoHS compliant.
- High common mode impedance at high frequency effects excellent noise suppression performance.
- CM322523 series realizes small size and low profile 3.2*2.5*2.3 mm.
- AEC-Q200 verified.

Parts Number Explanation

Example:

ECM	322523	L	510	F	T	W	A
Product Type	Size (mm)	Application	Impedance Inductance	HSF	Package	Internal Code	Optional
Common Mode Choke	322523	F: Impedance L: Inductance Products	L type: 110 : 11 uH +50/-30% 220 : 22 uH +50/-30% 510 : 51 uH +50/-30% 101 : 100 uH +50/-30%	Products (Hazardous Substance Free Products)	T : Taping		A : For Automotive Electronics



Common Mode Choke ECM322523L-TWA

Product Specifications

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Standard Electrical Specifications

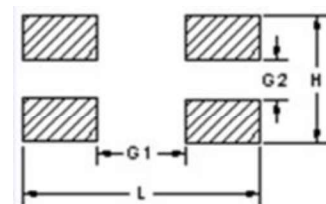
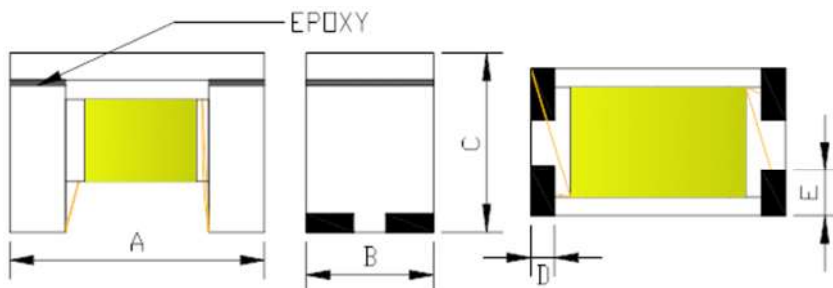
Part No.	Inductance @100KHZ/0.1V	Common mode Impedance Z @10MHz		DCR (1 line)	IR	Rated Current (Vdc)	Irms
	uH	Ω		m Ω	M Ω	V	mA
	+50%/-30%	Min.	Typ.	MAX	MIN	MAX	MAX
ECM322523L-110F-TWA	11	300	550	300	10	50	400
ECM322523L-220F-TWA	22	500	1100	500	10	50	300
ECM322523L-510F-TWA	51	1000	2600	700	10	50	200
ECM322523L-101F-TWA	100	2200	5100	1500	10	50	150

Notes:

1. All test data is referenced to 25 °C ambient.
2. Operating temperature range - 40 °C to + 125 °C. (Including self - temperature rise)
3. Irms (A): DC current (A) that will cause an approximate ΔT of 40 °C (reference ambient temperature is 25 °C).
4. The part temperature (ambient + temp rise) should not exceed 125 °C under worst case operating conditions.

Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions.
all affect the part temperature. Part temperature should be verified in the end application.

Dimensions



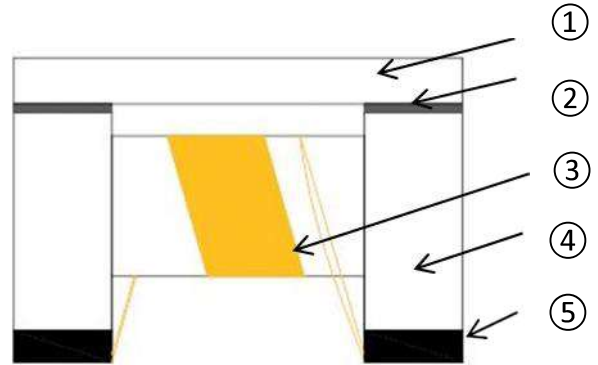
Recommend Land Pattern

Unit: mm

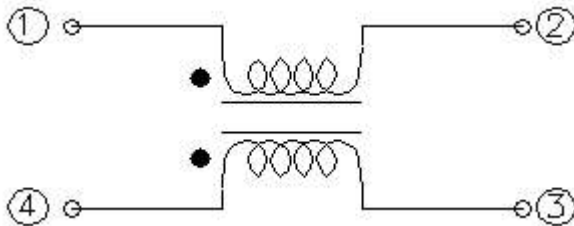
Type	A	B	C	D typ.	E typ.	L	H	G1	G2
ECM322523L	3.20 \pm 0.20	2.30 \pm 0.20	2.50 \pm 0.20	0.70	0.90	3.7	2.5	2.0	0.6

Structure and Components

Symbol	Components	Material name
①	LID	Ni-Zn Ferrite
②	EPOXY	Epoxy Resin
③	WIRE	Enameled copper wire
④	CORE	Ni-Zn Ferrite
⑤	Electrode structure	Ag + Ni + Sn plating

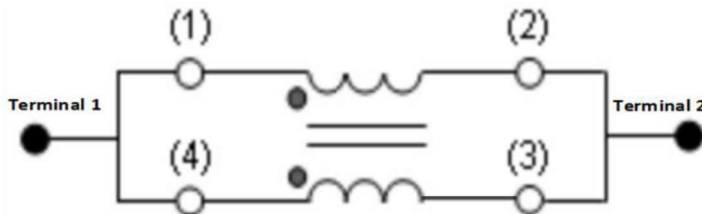


Chematic Diagram

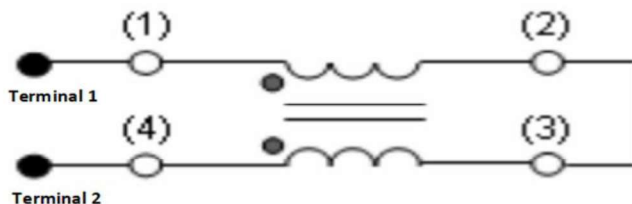


Measuring Circuits 2Line

1) Common mode :



2) Differential mode :

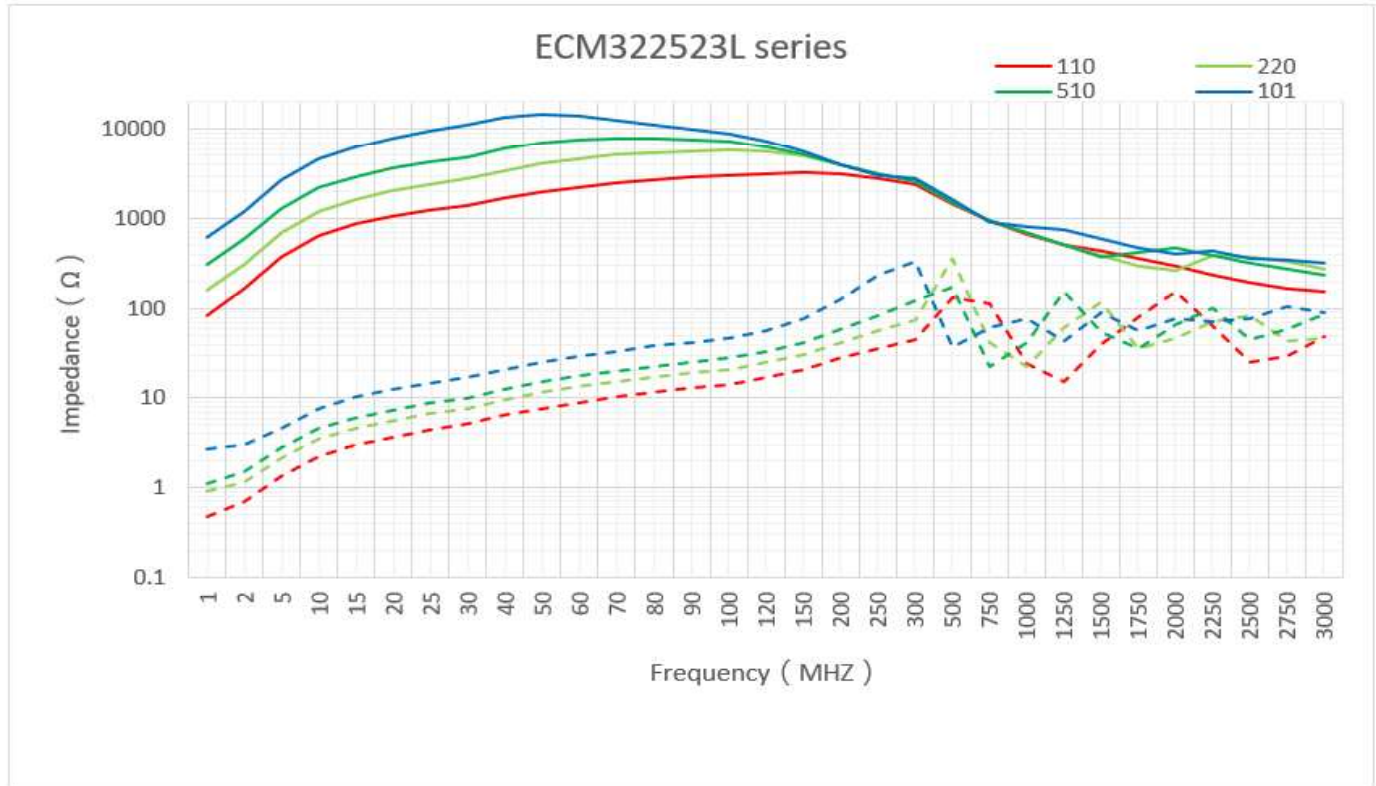




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■ Typical impedance vs. frequency :



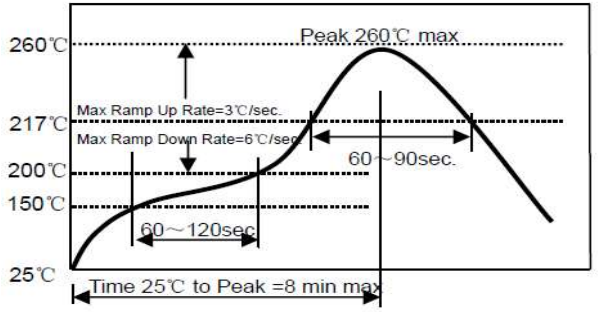


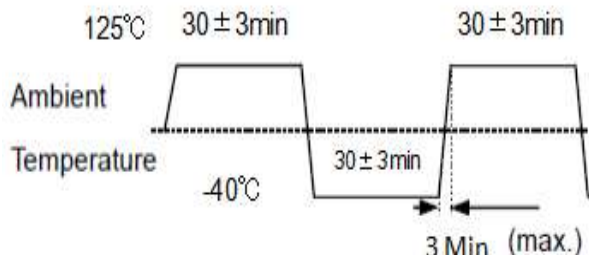
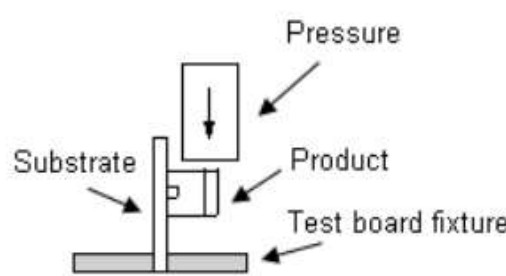
Common Mode Choke ECM322523L-TWA

Product Specifications

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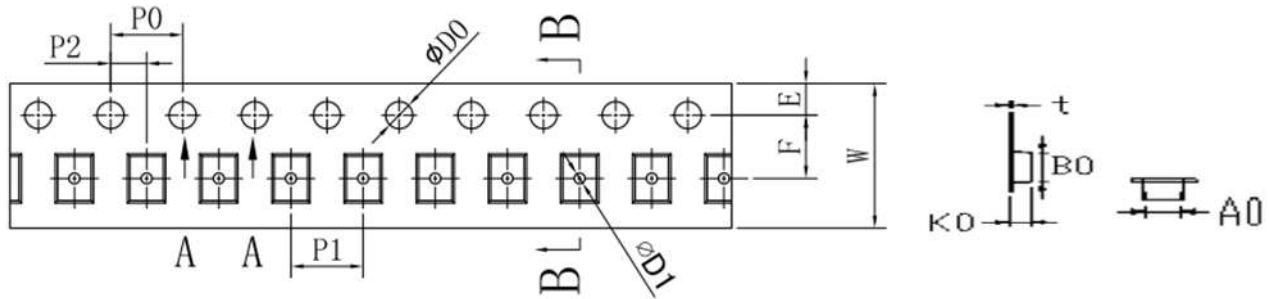
● Reliability test and requirement

Items	Requirements	Test Methods and Remarks
Operating life.	1. No visible mechanical damage. 2. Inductance change: Within $\pm 20\%$. Insulation resistance: 10M Ω min.	1. Reflow 2 times. 2. temperature: $155 \pm 2^\circ\text{C}$.
Resistance to Soldering Heat	1. No visible mechanical damage. 2. Impedance change: Within $\pm 20\%$.	1. Solder on PCB to Reflow test Peak Temp, $260 \pm 5^\circ\text{C}$ 5~10 secs. Cycles: 2 times Re-flowing. Profile: Please refer to Fig-1. 2. Test board thickness: 1.5mm. 3. Test board material: glass epoxy resin. 4. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made product showed no damage under microscope. Fig-1 
High Temperature	1. No visible mechanical damage. 2. Impedance change: Within $\pm 20\%$.	1. Temperature: $125 \pm 2^\circ\text{C}$. 2. Duration: 1000 hours The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.
Steady damp-heat	1. No visible mechanical damage. 2. Impedance change: Within $\pm 20\%$.	1. Temperature: 85°C . 2. Humidity: 85% RH. 3. Duration: 1000 hours. 4. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.
Mechanical Vibration	1. No visible mechanical damage. 2. Impedance change: Within $\pm 20\%$.	1. Frequency: 10HZ~55HZ~10HZ/Min Cycles. 2. Amplitude: 1.5 mm. 3. Directions: X, Y, Z. 4. Time: 2 hours in each direction (total of 6 hours).

Items	Requirements	Test Methods and Remarks
Thermal Shock	1. No visible mechanical damage. 2. Impedance change: Within $\pm 20\%$.	1. Temperature and time: -40°C for 30 ± 3 min \rightarrow 125°C for 30 ± 3 min, please refer to Fig-2. 2. Transforming interval: Max. 3 Min. 3. Tested cycle: 1000 cycles. 4. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made. Fig-2  <p>The diagram shows a temperature profile over time. It starts at 'Ambient Temperature', rises to 125°C for 30 ± 3 min, then drops to -40°C for 30 ± 3 min. After a 3 Min (max.) dwell at -40°C, it rises back to 125°C for another 30 ± 3 min. The temperature returns to 'Ambient' after each cycle.</p>
Salt Spray	1. No visible mechanical damage. 2. Impedance change: Within $\pm 20\%$.	1. Salt concentration: $(5 \pm 1) \%$ (mass percent). 2. pH value: 6.5 - 7.2. 3. temperature: $35 \pm 2^{\circ}\text{C}$. 4. humidity: 85%. 5. time: 24 hours. 6. in normal temperature and humidity for 1 ~ 2 hours, testing inductance, the inductance value change can not be more than before test $\pm 10\%$.
Terminal strength	1. No visible mechanical damage.	1. The electrode of the inductor is soldered to the PCB, to Fig-3 Then apply a force in the direction of the arrow. 2. 9N force. 3. Keep time: $10(\pm 1)$ s. The first three tests were OK, and the force was applied until the peak value of the product peeling. The test speed was set in the range of 3 ~ 8mm/min. Fig-3  <p>The diagram shows a cross-section of a test setup. A 'Product' is mounted on a 'Substrate'. A 'Test board fixture' is used to apply 'Pressure' (indicated by a downward arrow) to the product.</p>

■ Packaging Information

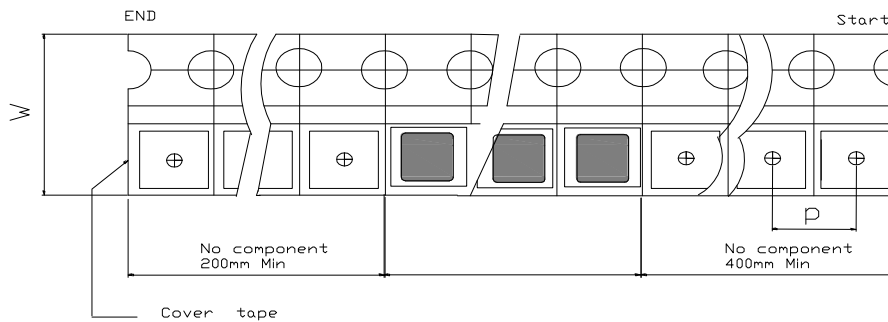
(1) Tape Packaging Dimensions (Unit : mm)



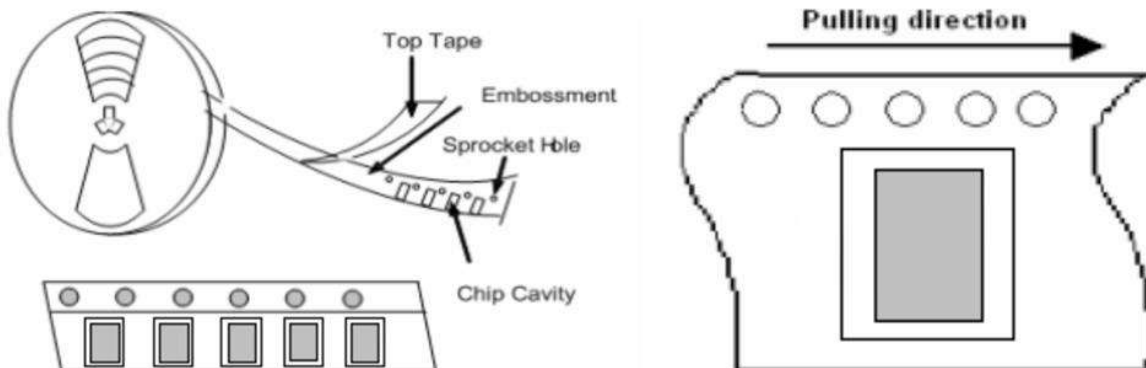
Unit : mm

Type	W	P1	A0	B0	K0	t	E	F	P2	D0	D1	P0
ECM322523L	8.00 ±0.10	4.00 ±0.10	2.85 ±0.10	3.65 ±0.10	2.55 ±0.10	0.26 ±0.05	1.75 ±0.10	3.50 ±0.10	2.00 ±0.10	1.55 ±0.05	0.60 ±0.05	4.00 ±0.10

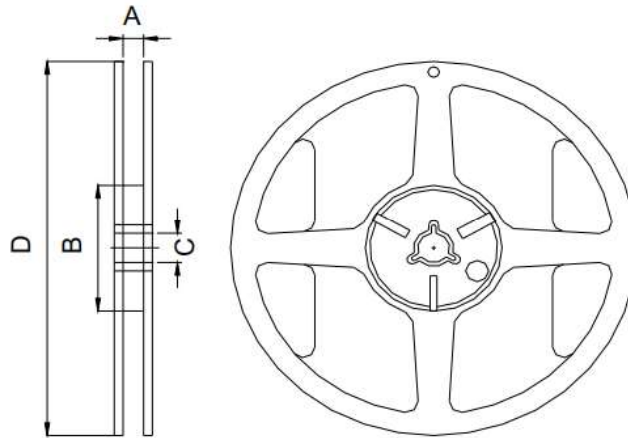
(2) Leader and blank portion



(3) Taping Drawings (Unit: mm)



(4) Reel Dimensions (Unit : mm)



Type	A	B	C	D
ECM322523L	9.50 ±1.0	60.0 ±1.0	13.0 ±0.2	178.0 ±1.0

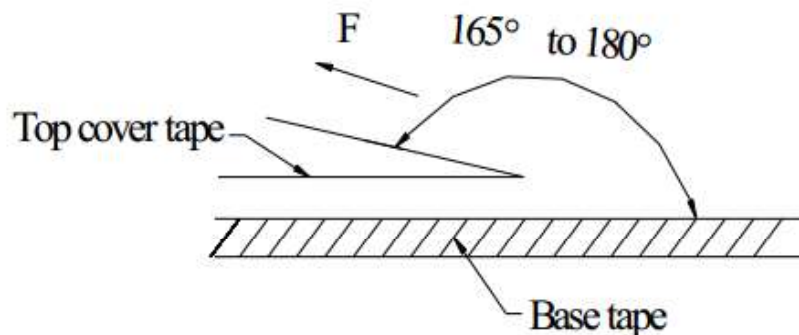
(5) Packaging Quantity (PCS)

Type	Standard Quantity		
	Reel	Inner box	Carton box
ECM322523L	1,500 pcs / reel	5Reel / box (7,500 pcs)	10 Middle boxes, (75,000 pcs)

(6) Peel force of top cover tape

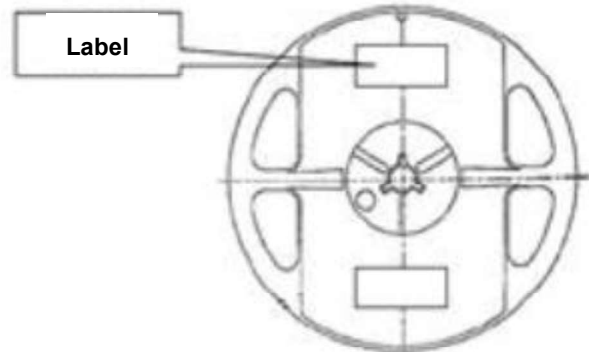
The peel speed shall be about 300mm/minute.

The peel force of top cover tape shall be between 10 to 100 gf

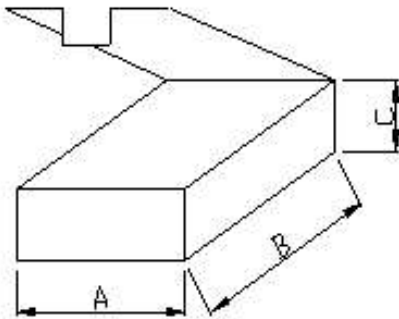


(7) Reel Label

- Label on the reel
 - Everohms part Number.
 - Lot Number
 - Quantity
 - Description.
- Shipping Label
 - Customer's part Number
 - Manufacturer's part Number
 - Quantity
 - date code

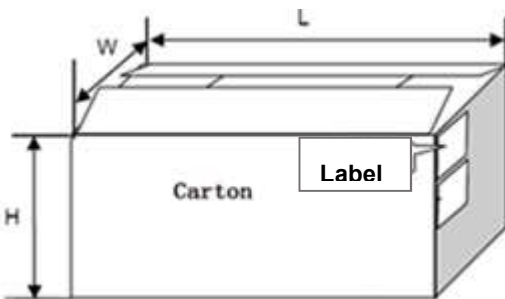


(8) Inner Box



Packaging Type	A (mm)	B (mm)	C (mm)
Inner box	188	195	67

(9) Carton



Packaging Type	L (mm)	W (mm)	H (mm)
Carton	390	350	215